
FIG 1: Power dissipation vs. on-state current

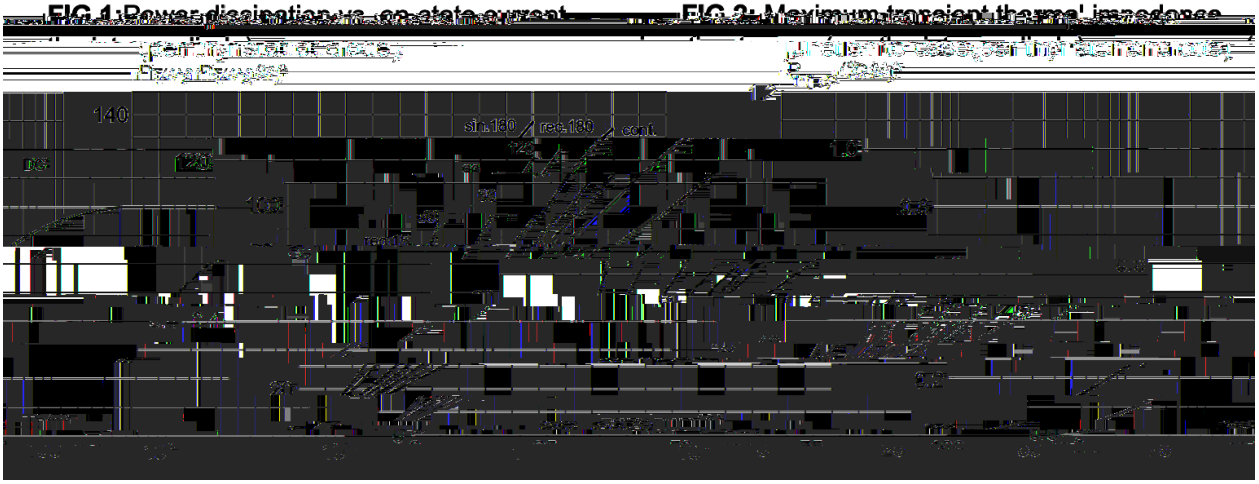


FIG 2: Maximum transient thermal impedance

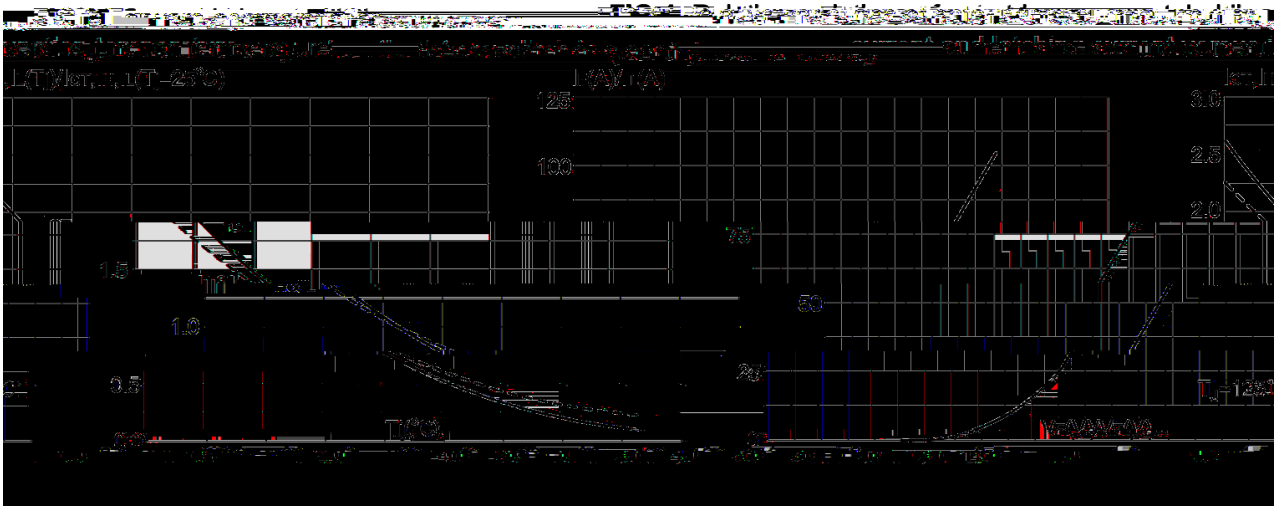


FIG 5: Typical gate characteristics

FIG 6: Forward current vs. case temperature

